

#### **General Description**

The MAX4090 3V/5V, 6dB video buffer with sync-tip clamp, and low-power shutdown mode is available in tiny SOT23, SC70, and µDFN packages. The MAX4090 is designed to drive DC-coupled,  $150\Omega$  back-terminated video loads in portable video applications such as digital still cams, portable DVD players, digital camcorders, PDAs, video-enabled cell phones, portable game systems, and notebook computers. The input clamp positions the video waveform at the output and allows the MAX4090 to be used as a DC-coupled output driver.

The MAX4090 operates from a single 2.7V to 5.5V supply and consumes only 6.5mA of supply current. The low-power shutdown mode reduces the supply current to 150nA, making the MAX4090 ideal for low-voltage, battery-powered video applications.

The MAX4090 is available in tiny 6-pin SOT23, SC70, and µDFN packages and is specified over the extended (-40°C to +85°C) and automotive (-40°C to +125°C) temperature ranges.

#### **Applications**

Portable Video/Game Systems/DVD Players Digital Camcorders/Televisions/Still Cameras **PDAs** 

Video-Enabled Cell Phones Notebook Computers Portable/Flat-Panel Displays

#### **Features**

- ♦ Single-Supply Operation from 2.7V to 5.5V
- ♦ Input Sync-Tip Clamp
- **♦ DC-Coupled Output**
- **♦ Low-Power Shutdown Mode Reduces Supply** Current to 150nA
- ♦ Available in Space-Saving SOT23, SC70 and µDFN Packages

#### **Ordering Information**

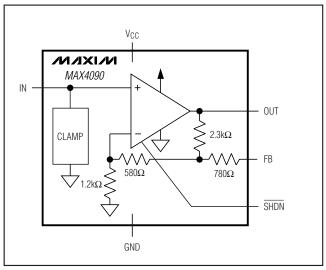
PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4090EXT-T	-40°C to +85°C	6 SC70-6	ABM
MAX4090EUT-T	-40°C to +85°C	6 SOT23-6	ABOX
MAX4090ELT-T*	-40°C to +85°C	6 μDFN-6	AAI
MAX4090AAXT-T	-40°C to +125°C	6 SC70-6	ACW
MAX4090AAUT-T	-40°C to +125°C	6 SOT23-6	ABWQ
MAX4090AALT-T*	-40°C to +125°C	6 μDFN-6	AAN

<sup>\*</sup>Future product—contact factory for availability.

#### **Pin Configurations**

#### TOP VIFW SHDN OUT 6 5 4 6 FB OUT 1 MIXIM GND 2 5 SHDN NIXINI MAX4090 IN 3 4 VCC 2 3 SC70/SOT23 GND IN Vcc $\mu$ **DFN**

### **Block Diagram**



MIXIM

Maxim Integrated Products 1

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND0.3V to +6V OUT, FB, SHDN to GND0.3V to (V <sub>CC</sub> + 0.3V)	6-Pin µDFN (derate 3.6mW/°C above +70°C)290mW Operating Temperature Range
IN to GND (Note 1)V <sub>CLP</sub> to (V <sub>CC</sub> + 0.3V)	MAX4090E40°C to +85°C
IN Short-Circuit Duration from -0.3V to VCLP1min	MAX4090A40°C to +125°C
Output Short-Circuit Duration to V <sub>CC</sub> or GND Continuous	Junction Temperature+150°C
Continuous Power Dissipation (TA = +70°C)	Storage Temperature Range65°C to +150°C
6-Pin SOT23 (derate 8.7mW/°C above +70°C)695mW	Lead Temperature (soldering, 10s)+300°C
6-Pin SC70 (derate 3.1mW/°C above +70°C)245mW	

Note 1: VCLP is the input clamp voltage as defined in the DC Electrical Characteristics table.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC}=3.0V,~GND=0V,~C_{IN}=0.1\mu F~from~IN~to~GND,~R_L=infinity~to~GND,~FB~shorted~to~OUT,~\overline{SHDN}=3.0V,~T_A=-40^{\circ}C~to~+85^{\circ}C~(MAX4090E),~T_A=-40^{\circ}C~to~+125^{\circ}C~(MAX4090A).$  Typical values are at  $T_A=+25^{\circ}C,~unless~otherwise~noted.$ ) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage Range	Vcc	Guaranteed by PSRR	Guaranteed by PSRR			5.5	V
0.:	1	M. M.	V <sub>CC</sub> = 3V		6.5	10	A
Quiescent Supply Current	Icc	VIN = VCLP	V <sub>CC</sub> = 5V		6.5	10	mA
Shutdown Supply Current	ISHDN	SHDN = 0V			0.15	1	μΑ
Input Clamp Voltage	VCLP	Input referred		0.27	0.38	0.47	V
Input Voltage Range	VIN	Inferred from voltage	gain (Note 3)	VCLP		1.45	V
Input Bias Current	I <sub>BIAS</sub>	V <sub>IN</sub> = 1.45V			22.5	35	μΑ
Input Resistance		V <sub>CLP</sub> + 0.5V < V <sub>IN</sub> < '	V <sub>CLP</sub> + 1V		3		МΩ
Voltage Gain	A <sub>V</sub>	$R_L = 150\Omega$ , $0.5V < V_{IN} < 1.45V$ (Note 4)		1.9	2	2.1	V/V
Power-Supply Rejection Ratio	PSRR	2.7V < V <sub>CC</sub> < 5.5V		60	80		dB
Outrook Valta and High Continue	V.	D 4500 + OND	V <sub>CC</sub> = 3V	2.55	2.7		
Output-Voltage High Swing	Voн	$R_L = 150\Omega$ to GND	V <sub>CC</sub> = 5V	4.3	4.6		V
Output-Voltage Low Swing	VoL	$R_L = 150\Omega$ to GND			VCLP	0.47	V
Output Ourrent	1	Sourcing, $R_L = 20\Omega$ to	o GND	45	85		A
Output Current	lout	Sinking, $R_L = 20\Omega$ to	Vcc	40	85		mA
Output Short-Circuit Current	Isc	OUT shorted to VCC	or GND		110		mA
SHDN Logic-Low Threshold	VIL					V <sub>CC</sub> x 0.3	V
SHDN Logic-High Threshold	VIH			V <sub>CC</sub> x 0.7	7		V
SHDN Input Current	IIH				0.003	1	μΑ
			At DC		4		
Shutdown Output Impedance	ROUT (Disabled)	SHDN = 0V	At 3.58MHz or 4.43MHz		2		kΩ

#### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC}=3.0V,\,GND=0V,\,FB\,$  shorted to OUT,  $C_{IN}=0.1\mu F,\,R_{IN}=75\Omega$  to GND,  $R_{L}=150\Omega$  to GND,  $\overline{SHDN}=V_{CC},\,T_{A}=+25^{\circ}C,\,$  unless otherwise noted.)

PARAMETER	SYMBOL	COND	DITIONS	MIN	TYP	MAX	UNITS
Small-Signal -3dB Bandwidth	BWSS	$V_{OUT} = 100 \text{mV}_{P-P}$	$V_{OUT} = 100 \text{mVp-p}$		55		MHz
Large-Signal -3dB Bandwidth	BWLS	V <sub>OUT</sub> = 2V <sub>P-P</sub>			45		MHz
Small-Signal 0.1dB Gain Flatness	BW <sub>0.1dBSS</sub>	$V_{OUT} = 100 \text{mV}_{P-P}$			25		MHz
Large-Signal 0.1dB Gain Flatness	BW <sub>0.1dBLS</sub>	V <sub>OUT</sub> = 2V <sub>P-P</sub>			17		MHz
Slew Rate	SR	V <sub>OUT</sub> = 2V step			275		V/µs
Settling Time to 0.1%	ts	V <sub>OUT</sub> = 2V step			25		ns
Power-Supply Rejection Ratio	PSRR	f = 100kHz			50		dB
Output Impedance	Z <sub>OUT</sub>	f = 5MHz			2.5		Ω
Differential Gain	DG	NTSC	$V_{CC} = 3V$		1		_ %
Differential Gain	DG	$V_{CC} = 5V$ 0.5			/0		
Differential Phase	DP	NTSC	$V_{CC} = 3V$		0.8		Dograda
Differential Friase	DF	MISC	$V_{CC} = 5V$		0.5		Degrees
Group Delay	D/dT	f = 3.58MHz or 4.43N	ЛНz		20		ns
Peak Signal to RMS Noise	SNR	$V_{IN} = 1V_{P-P}$ , $10MHz$	BW		65		dB
Droop		$C_{IN} = 0.1 \mu F \text{ (Note 4)}$			2	3	%
SHDN Enable Time	ton	$V_{IN} = V_{CLP} + 1V$ , $\overline{SHDN} = 3V$ , $V_{OUT}$ settled to within 1% of the final voltage			250		ns
SHDN Disable Time	toff	VIN = V <sub>CLP</sub> + 1V, SHI to below 1% of the ou	DN = 0V, V <sub>OUT</sub> settled utput voltage		50		ns

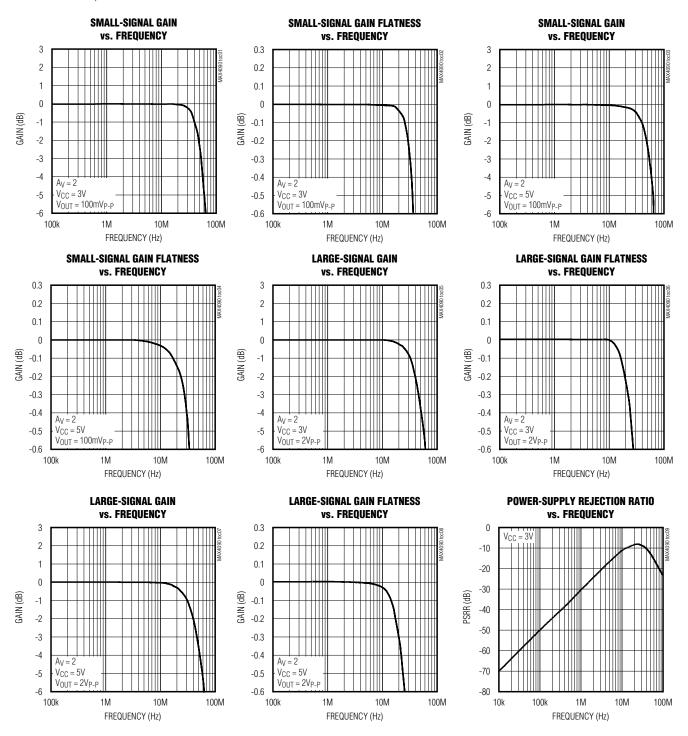
Note 2: All devices are 100% production tested at  $T_A = +25^{\circ}C$ . Specifications over temperature limits are guaranteed by design.

Note 3: Voltage gain (A<sub>V</sub>) is referenced to the clamp voltage, i.e., an input voltage of  $V_{IN} = V_{CLP} + VI$  would produce an output voltage of  $V_{OUT} = V_{CLP} + A_V \times VI$ .

Note 4: Droop is guaranteed by the Input Bias Current specification.

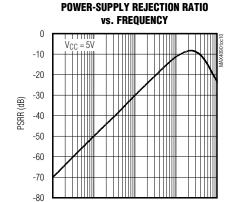
#### **Typical Operating Characteristics**

 $(V_{CC}=3.0V, \text{ GND}=0V, \text{ FB shorted to OUT}, C_{IN}=0.1\mu\text{F}, R_{IN}=75\Omega \text{ to GND}, R_L=150\Omega \text{ to GND}, \overline{SHDN}=V_{CC}, T_A=+25^{\circ}\text{C}, \text{ unless otherwise noted.})$ 



#### Typical Operating Characteristics (continued)

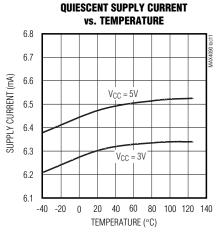
 $(V_{CC}=3.0V, GND=0V, FB \text{ shorted to OUT}, C_{IN}=0.1\mu F, R_{IN}=75\Omega \text{ to GND}, R_{L}=150\Omega \text{ to GND}, \overline{SHDN}=V_{CC}, T_{A}=+25^{\circ}C, unless otherwise noted.)}$ 

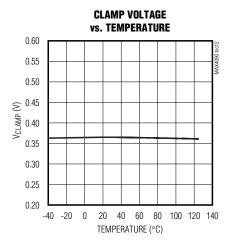


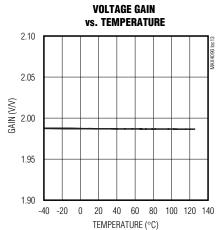
1M

FREQUENCY (Hz)

10k

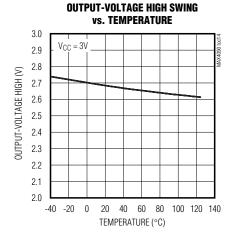


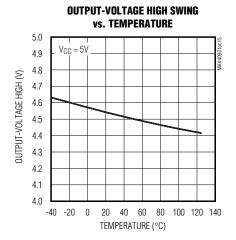


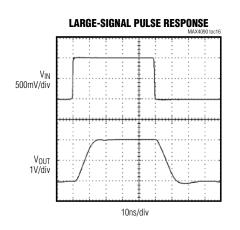


10M

100M

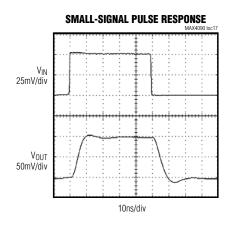


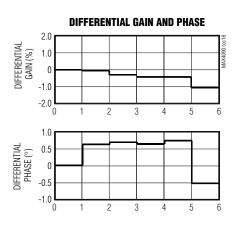




### Typical Operating Characteristics (continued)

 $(V_{CC}=3.0V, GND=0V, FB \text{ shorted to OUT}, C_{IN}=0.1\mu F, R_{IN}=75\Omega \text{ to GND}, R_L=150\Omega \text{ to GND}, \overline{SHDN}=V_{CC}, T_A=+25^{\circ}C, unless otherwise noted.)}$ 

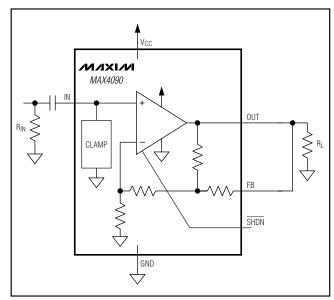




#### **Pin Description**

PI	N			
SOT23/ SC70	μDFN	NAME	FUNCTION	
1	4	OUT	Video Output	
2	2	GND	Ground	
3	3	IN	Video Input	
4	1	Vcc	Power-Supply Voltage. Bypass with a 0.1µF capacitor to ground as close to pin as possible.	
5	5	SHDN	Shutdown. Pull SHDN low to place the MAX4090 in low-power shutdown mode.	
6	6	FB	Feedback. Connect to OUT.	

### **Typical Application Circuit**



#### **Detailed Description**

The MAX4090 3V/5V, 6dB video buffer with sync-tip clamp and low-power shutdown mode is available in tiny SOT23 and SC70 packages. The MAX4090 is designed to drive DC-coupled,  $150\Omega$  back-terminated video loads in portable video applications such as digital still cams, portable DVD players, digital camcorders, PDAs, videoenabled cell phones, portable game systems, and notebook computers. The input clamp positions the video waveform at the output and allows the MAX4090 to be used as a DC-coupled output driver.

The MAX4090 operates from a single 2.7V to 5.5V supply and consumes only 6.5mA of supply current. The low-power shutdown mode reduces the supply current to 150nA, making the MAX4090 ideal for low-voltage, battery-powered video applications.

The input signal to the MAX4090 is AC-coupled through a capacitor into an active sync-tip clamp circuit, which places the minimum of the video signal at approximately 0.38V. The output buffer amplifies the video signal while still maintaining the 0.38V clamp voltage at the output. For example, if  $V_{IN} = 0.38V$ , then  $V_{OUT} = 0.38V$ . If  $V_{IN} = (0.38V + 1V) = 1.38V$ , then  $V_{OUT} = (0.38V + 2 \text{ X}(1V)) = 2.38V$ . The net result is that a 2V video output signal swings within the usable output voltage range of the output buffer when  $V_{CC} = 3V$ .

#### **Shutdown Mode**

The MAX4090 features a low-power shutdown mode ( $\overline{\text{ISHDN}} = 150\text{nA}$ ) for battery-powered/portable applications. Pulling the  $\overline{\text{SHDN}}$  pin high enables the output. Connecting the  $\overline{\text{SHDN}}$  pin to ground (GND) disables the output and places the MAX4090 into a low-power shutdown mode.

## Applications Information Input Coupling the MAX4090

The MAX4090 input must be AC-coupled because the input capacitor stores the clamp voltage. The MAX4090 requires a typical value of 0.1µF for the input clamp to meet the Line Droop specification. A minimum of a ceramic capacitor with an X7R temperature coefficient is recommended to avoid temperature-related problems with Line Droop. For extended temperature operation, such as outdoor applications, or where the impressed voltage is close to the rated voltage of the capacitor, a film dielectric is recommended. Increasing the capacitor value slows the clamp capture time. Values above 0.5µF should be avoided since they do not improve the clamp's performance.

The active sync-tip clamp also requires that the input impedance seen by the input capacitor be less than  $100\Omega$  typically to function properly. This is easily met by the  $75\Omega$  input resistor prior to the input-coupling capacitor and the back termination from a prior stage. Insufficient input resistance to ground causes the MAX4090 to appear to oscillate. Never operate the MAX4090 in this mode.

#### Using the MAX4090 with the Reconstruction Filter

In most video applications, the video signal generated from the DAC requires a reconstruction filter to smooth out the signal and attenuate the sampling aliases. The MAX4090 is a direct DC-coupled output driver, which can be used after the reconstruction filter to drive the video signal. The driving load from the video DAC can be varied from  $75\Omega$  to  $300\Omega$ . A low input impedance (< $100\Omega$ ) is required by the MAX4090 in normal operation, special care must be taken when a reconstruction filter is used in front of the MAX4090.

For standard video signal, the video passband is about 6MHz and the system oversampling frequency is at 27MHz. Normally, a 9MHz BW lowpass filter can be used for the reconstruction filter. This section demonstrates the methods to build simple 2nd- and 3rd-order passive butterworth lowpass filters at the 9MHz cutoff frequency and the techniques to use them with the MAX4090 (Figures 1 and 4).

# 2nd-Order Butterworth Lowpass Filter Realization Table 1 shows the normalized 2nd-order butterworth LPF component values at 1rad/s with a source/load impedance of $1\Omega$ .

With the following equations, the L and C can be calculated for the cutoff frequency at 9MHz. Table 2 shows the appropriated L and C values for different source/load impedance, the bench measurement values for the -3dB BW and attenuation at 27MHz. There is approximately 20dB attenuation at 27MHz, which effectively attenuates the sampling aliases. The MAX4090 requires low input impedance for stable operation and it does not like the reactive input impedance. For R1/R2 greater than 100 $\Omega$ , a series resistor RIS (Figure 1)

Table 1. 2nd-Order Butterworth Lowpass Filter Normalized Values

$Rn1 = Rn2 (\Omega)$	Cn1 (F)	Ln1 (H)
1	1.414	1.414

between  $20\Omega$  to  $100\Omega$  is needed to isolate the input capacitor (C4) to the filter to prevent the oscillation problem.

$$C = \frac{C_n}{2\pi f_C R_l} L = \frac{L_n R_L}{2\pi f_C}$$

Figure 2 shows the frequency response for R1 = R2 =  $150\Omega$ . At 6MHz, the attenuation is about 1.4dB. The attenuation at 27MHz is about 20dB. Figure 3 shows the multiburst response for R1 = R2 =  $150\Omega$ .

#### 3rd-Order Butterworth Lowpass Filter Realization

If more flat passband and more stopband attenuation are needed, a 3rd-order LPF can be used. The design procedures are similar to the 2nd-order butterworth LPF.

Table 3 shows the normalized 3rd-order butterworth lowpass filter with the cutoff frequency at 1 rad/s and the stopband frequency at 3 rad/s. Table 4 shows the appropriated L and C values for different source/load impedance and the bench measurement values for -3dB BW and attenuation at 27MHz. The attenuation is over 40dB at 27MHz. At 6MHz, the attenuation is approximately 0.6dB for R1 = R2 =  $150\Omega$  (Figure 5).

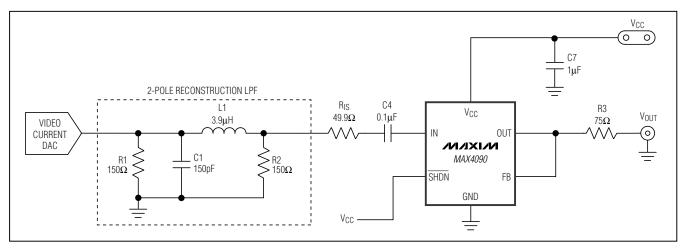


Figure 1. 2nd-Order Butterworth LPF with MAX4090

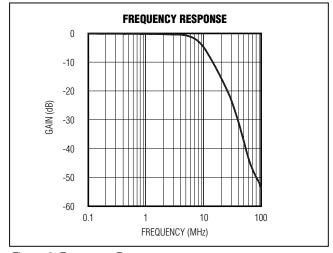


Figure 2. Frequency Response

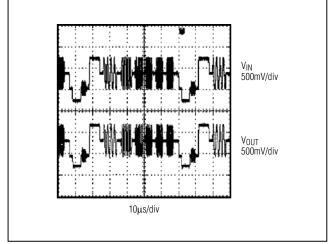


Figure 3. Multiburst Response

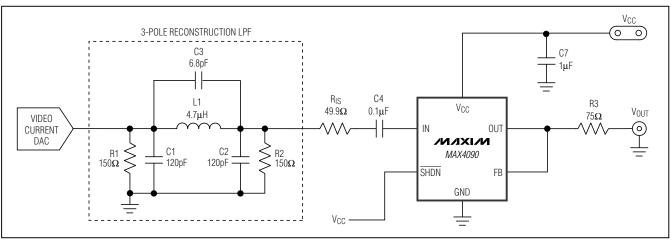


Figure 4. 3rd-Order Butterworth LPF with MAX4090

#### **Table 2. Bench Measurement Values**

R1 = R2 (Ω)	C1 (pf)	L1 (μΗ)	R <sub>IS</sub> (Ω)	3dB BW (MHz)	ATTENUATION AT 27MHz (dB)
75	330	1.8	0	8.7	20
150	150	3.9	50	9.0	20
200	120	4.7	50	9.3	22
300	82	8.2	100	8.7	20

## **Table 3. 3rd-Order Butterworth Lowpass Filter Normalized Values**

$Rn1 = Rn2$ ( $\Omega$ )	Cn1 (F)	Cn2 (F)	Cn3 (F)	Ln1 (H)	
1	0.923	0.923	0.06	1.846	

#### Table 4. Bench Measurement Values

$\mathbf{R1} = \mathbf{R2} \; (\Omega)$	C1 (pF)	C2 (pF)	C3 (pF)	L (µH)	R <sub>IS</sub> (Ω)	3dB BW (MHz)	ATTENUATION AT 27MHz (dB)
75	220	220	15.0	2.2	0	9.3	43
150	120	120	6.8	4.7	50	8.9	50
300	56	56	3.3	10.0	100	9.0	45

#### Sag Correction

In a 5V application, the MAX4090 can use the sag configuration if an AC-coupled output video signal is required. Sag correction refers to the low-frequency compensation for the highpass filter formed by the  $150\Omega$  load and the output capacitor. In video applications, the cutoff frequency must be low enough to pass the vertical sync interval to avoid field tilt. This cutoff frequency should be less than 5Hz, and the coupling capacitor must be very large in normal configuration,

typically > 220 $\mu$ F. In sag configuration, the MAX4090 eliminates the need for large coupling capacitors, and instead requires two 22 $\mu$ F capacitors (Figure 6) to reach the same performance as the large capacitor. Bench experiments show that increasing the output coupling capacitor C5 beyond 47 $\mu$ F does not improve the performance. If the supply voltage is less than 4.5V, the sag correction is not recommended for the MAX4090.

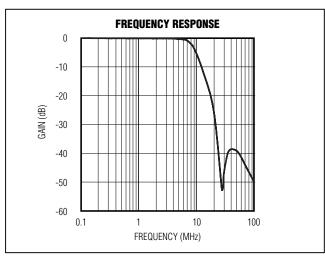


Figure 5. Frequency Response for R1 = R2 =  $150\Omega$ 

#### **Layout and Power-Supply Bypassing**

The MAX4090 operates from single 2.7V to 5.5V supply. Bypass the supply with a 0.1µF capacitor as close to the pin as possible. Maxim recommends using microstrip and stripline techniques to obtain full bandwidth. To ensure that the PC board does not degrade the device's performance, design it for a frequency greater than 1GHz. Pay careful attention to inputs and outputs to avoid large parasitic capacitance. Whether or not you use a constant-impedance board, observe the following design guidelines:

- Do not use wire-wrap boards; they are too inductive.
- Do not use IC sockets; they increase parasitic capacitance and inductance.
- Use surface-mount instead of through-hole components for better, high-frequency performance.
- Use a PC board with at least two layers; it should be as free from voids as possible.
- Keep signal lines as short and as straight as possible.
   Do not make 90° turns; round all corners.

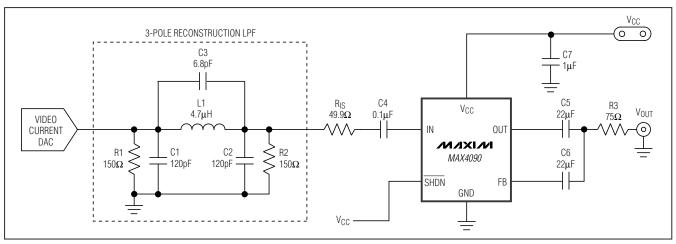


Figure 6. Sag Correction Configuration

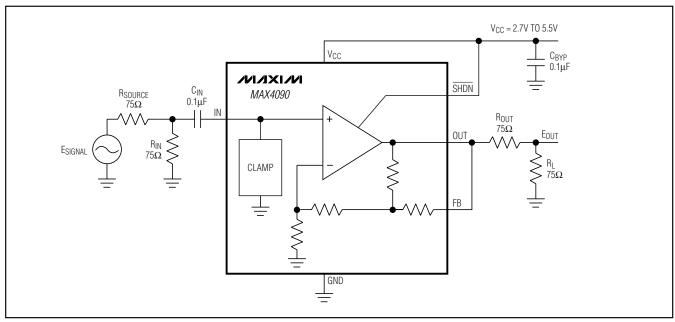


Figure 7. Typical Operating Circuit

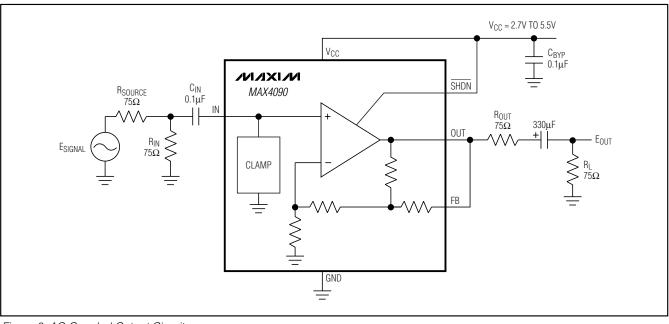


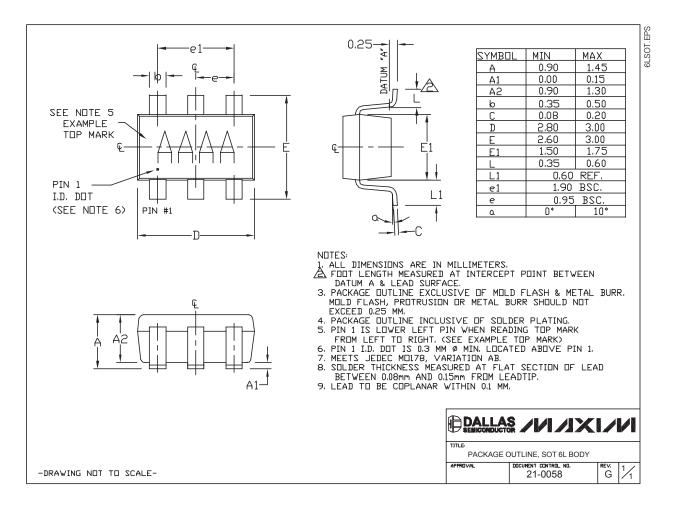
Figure 8. AC-Coupled Output Circuit

\_Chip Information

TRANSISTOR COUNT: 755
PROCESS: BICMOS

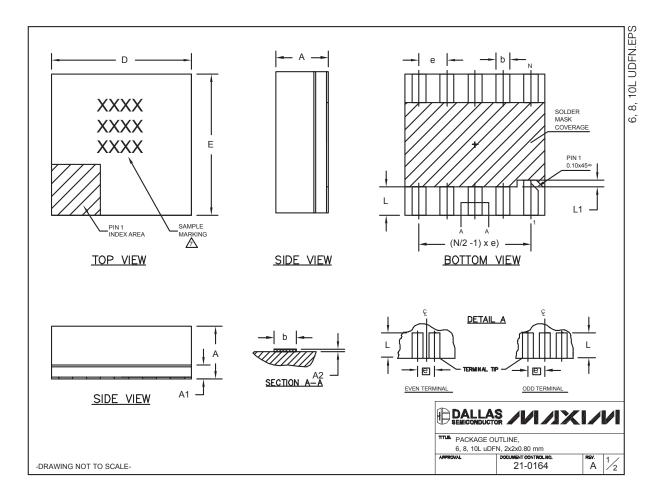
#### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS							
SYMBOL	MIN.	MIN. NOM. MAX.					
Α	0.70	0.75	0.80				
A1	0.15	0.20	0.25				
A2	0.020	0.025	0.035				
D	1.95	2.00	2.05				
Е	1.95	2.00	2.05				
L	0.30	0.40	0.50				
L1	0.10 REF.						

PACKAGE VARIATIONS						
PKG. CODE	N	е	b	(N/2 -1) x e		
L622-1	6	0.65 BSC	0.30±0.05	1.30 REF.		
L822-1	8	0.50 BSC	0.25±0.05	1.50 REF.		
L1022-1	10	0.40 BSC	0.20±0.03	1.60 REF.		

- NOTES:
  1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
  2. COPLANARITY SHALL NOT EXCEED 0.08mm.
  3. WARPAGE SHALL NOT EXCEED 0.10mm.

- 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
- 5. "N" IS THE TOTAL NUMBER OF LEADS.
  6. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

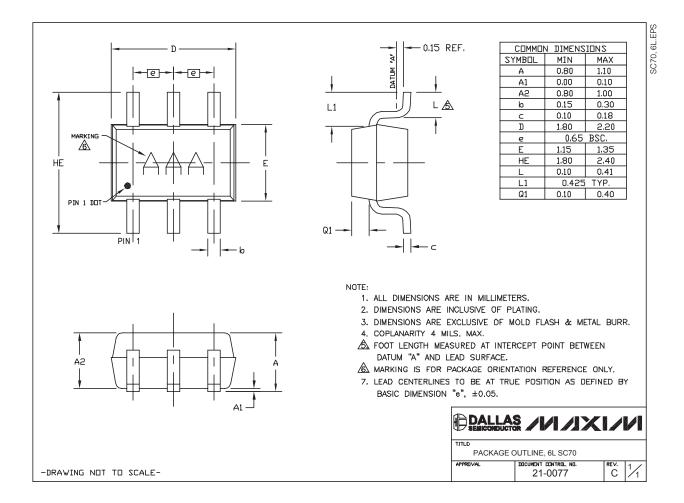
  MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-



#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.